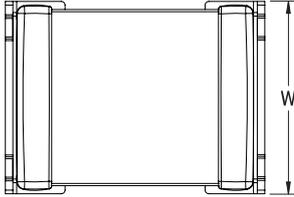
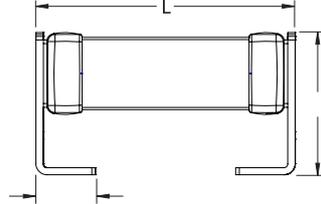


TOP VIEW
Single or Double Chip Stack



PROFILE VIEW
Single Chip Stack



Click [here](#) for the 3D model.

Dimensions

L	3.5mm +/-0.3mm
W	2.6mm +/-0.3mm
T	3.35mm +/-0.10mm
B	0.8mm +/-0.15mm

Packaging Specifications

包装	T&R, 180mm, Plastic Tape
包装数量	600

General Information

类别	KPS SMD Comm X7R
样式	Stacked Chip
描述	SMD, MLCC, Stacked, Single Chip, Temperature Stable
特征	Temperature Stable
RoHS	Yes
端子	Tin
典型元件重量	160 mg
保质期	78 Weeks
MSL	1

Specifications

容值	10 uF
测量条件	1 kHz 1.0Vrms
容差	10%
直流电压	25 VDC
耐压电压	62.5 VDC
温度范围	-55/+125°C
温度系数	X7R
电容变化 (相对于+25°C, 0 VDC) (TCC)	15%, 1kHz 1.0Vrms
损耗因数	10% 1 kHz 1.0Vrms
老化率	3% Loss/Decade Hour: Referee Time is 1000 Hours
绝缘阻抗	50 MOhms

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